

# **CORROSION PREVENTION ON COPPER**

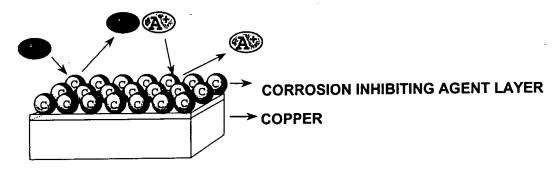
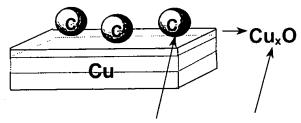


FIGURE 1





## **CONTAMINATION TEST**



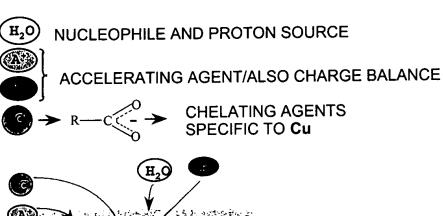
SAMPLE**	Cu (atoms/cm²)	F (atoms/cm²)	C (atoms/cm <sup>2</sup> )	Cu <sub>2</sub> O (Å)
CONTROL	1.6 x 10 <sup>10</sup>	3.3 x 10 <sup>13</sup>	$7.5 \times 10^{13}$	42
Matrix 2 +	8.5 x 10 <sup>9</sup>	5.1 x 10 <sup>13</sup>	1.5 x 10 <sup>13</sup>	15
IMINODIACETIC				
ACID INHIBITOR				

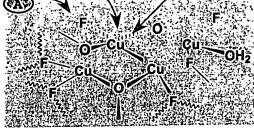
<sup>\*</sup> Blanket Cu and Si Films Processed Together, 20 mL of Chemical (25 °C @ 15 min, DI Water Rinse)

FIGURE 2

<sup>\*\*</sup> Average of 3 Points

#### ATMI-0396 CIP II Sheet 3 of 6





INSOLUBLE INORGANIC SLURRY AND RESIDUES

FIGURE 3

#### ATMI-0396 CIP II Sheet 4 of 6

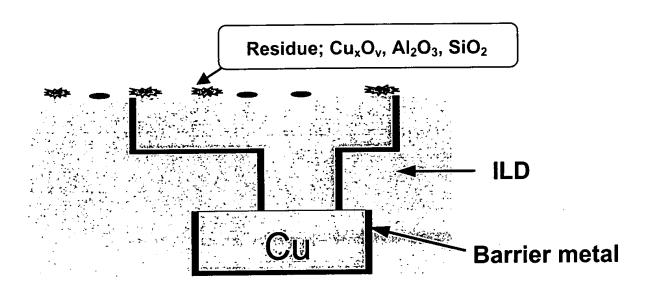


FIGURE 4

### ATMI-0396 CIP II Sheet 5 of 6

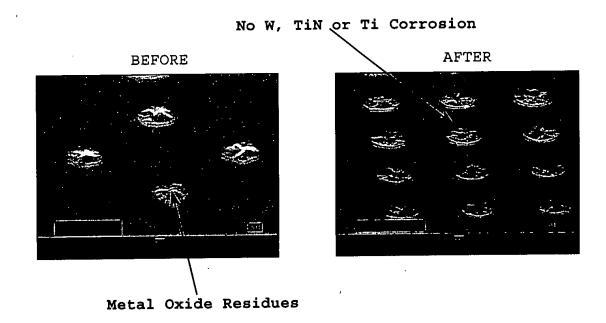


FIGURE 5

## ATMI-0396 CIP II Sheet 6 of 6

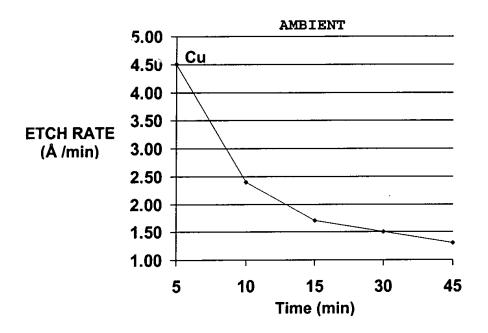


FIGURE 6